

# 1A, 400V - 1000V Surface Mount Rectifier

# **FEATURES**

- · Glass passivated junction chip
- Ideal for automated placement
- Low forward voltage drop
- · High surge current capability
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

#### **APPLICATIONS**

- High frequency rectification
- Freewheeling application
- Switching mode converters and inverters in computer and telecommunication.

#### **MECHANICAL DATA**

- Case: SOD-123FL
- Molding compound meets UL 94 V-0 flammability rating
- Moisture sensitivity level: level 1, per J-STD-020
- Packing code with suffix "G" means green compound (halogen-free)
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 1A whisker test
- Polarity: As marked
- Weight: 16 mg (approximately)

KEY PARAMETERS				
PARAMETER	VALUE	UNIT		
I <sub>F(AV)</sub>	1	Α		
$V_{RRM}$	400 - 1000	V		
I <sub>FSM</sub>	30	Α		
T <sub>J MAX</sub>	150 °C			
Package	SOD-123FL			
Configuration	Single dice			









SOD-123FL

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)					
PARAMETER	SYMBOL	S1GFL	S1JFL	S1MFL	UNIT
Marking code on the device		SGF	SJF	SMF	
Repetitive peak reverse voltage	$V_{RRM}$	400	600	1000	V
Reverse voltage, total rms value	$V_{RMS}$	280	420	700	V
Maximum DC blocking voltage	$V_{DC}$	400	600	1000	
Forward current	I <sub>F(AV)</sub>	1		Α	
Surge peak forward current, 8.3 ms single half sinewave superimposed on rated load per diode	I <sub>FSM</sub>	30		А	
Junction temperature	T <sub>J</sub>	- 55 to +150		°C	
Storage temperature	T <sub>STG</sub>		- 55 to +150		°C

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THERMAL PERFORMANCE					
PARAMETER	SYMBOL	TYP	UNIT		
Junction to Lead Thermal Resistance	$R_{\Theta JL}$	25	°C/W		
Junction to Ambient Thermal Resistance	$R_{\Theta JA}$	85	°C/W		

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage (1)	I <sub>F</sub> = 1A, T <sub>J</sub> = 25°C	V <sub>F</sub>	-	1.1	V
Reverse current @ rated V <sub>R</sub> per diode (2)	T <sub>J</sub> = 25°C	I <sub>R</sub>	-	1	μA
	T <sub>J</sub> = 125°C		-	50	μA
Junction capacitance	1 MHz, V <sub>R</sub> =4V	C <sub>J</sub>	7	-	pF

#### Notes:

- 1. Pulse test with PW=0.3 ms
- 2. Pulse test with PW=30 ms

ORDERING INFORMATION						
PART NO.	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING		
S1xFL	RV	0	SOD-123FL	3,000 / 7" Plastic reel		
(Note1, 2)	RQ	G	SOD-123FL	10,000 / 13" Paper reel		

#### Notes:

- 1. "x" defines voltage from 400V (S1GFL) to 1000V (S1MFL)
- 2. Whole series with green compound

EXAMPLE					
EXAMPLE P/N	PART NO.	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION	
S1MFL RVG	S1MFL	RV	G	Green compound	



# **CHARACTERISTICS CURVES**

(T<sub>A</sub> = 25°C unless otherwise noted)

Fig.1 Forward Current Derating Curve

1.2 AVERAGE FORWARD CURRENT (A) 1 8.0 0.6 0.4 0.2 Resistive or inductive load 0 25 50 75 100 125 150 0 LEAD TEMPERATURE (°C)

Fig.2 Typical Junction Capacitance

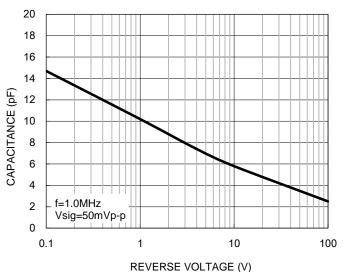


Fig.3 Typical Reverse Characteristics

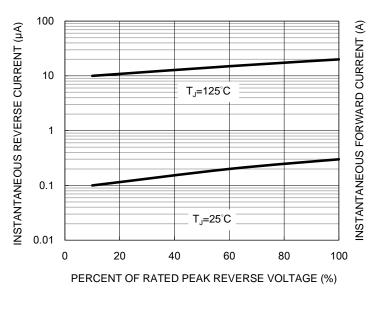
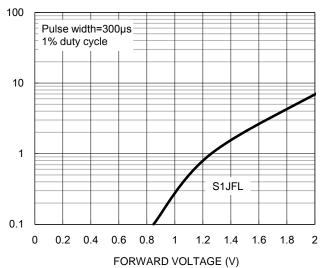


Fig.4 Typical Forward Characteristics



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# **CHARACTERISTICS CURVES**

(T<sub>A</sub> = 25°C unless otherwise noted)

Fig.5 Maximum Non-repetitive Forward Surge Current

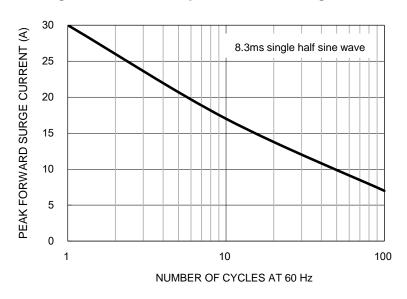
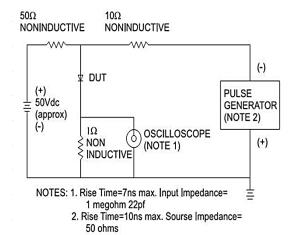
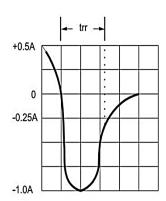


Fig.6 Reverse Recovery Time Characteristic And Test Circuit Diagram

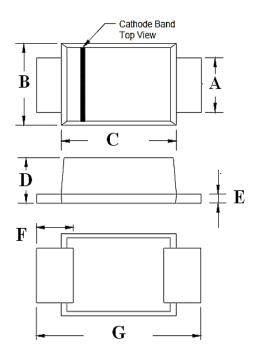






# **PACKAGE OUTLINE DIMENSIONS**

SOD-123FL



DIM	Unit (mm)		Unit (inch)		
DIM.	Min	Max	Min	Max	
Α	0.80	1.15	0.031	0.045	
В	1.70	2.10	0.067	0.083	
С	2.60	3.10	0.102	0.122	
D	0.88	1.35	0.035	0.053	
Е	0.10	0.30	0.004	0.012	
F	0.30	0.90	0.012	0.035	
G	3.45	3.95	0.136	0.156	

# **MARKING DIAGRAM**



= Marking Code P/N ΥW = Date Code = Factory Code



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